| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|----------|--------------|--|---|---------------------|-----------|--------------------------------------|
| LI | 15 | "6187874" "6210811" | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ОИ | 2006/02/13 09:36 |
| L2 | 3460 | polyimide with ((film sheet) near3 adhesive) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:41 |
| L3 | 8252 | protective with ((film sheet) near3 adhesive) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:41 |
| L4 | 197 | 12 and 13 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:41 |
| L5 | .927 | polyimide with (phenol phenolic) with (bearing modified) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT | OR | ON | 2006/02/13 11:16 |
| L6 | 1 | L5 and 14 | ; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:42 |
| L7 L8 | 181577 71 | epoxy L7 and l4 | USPAT US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR OR | OFF ON | 2006/02/13 09:42 2006/02/13 09:42 |
| L9 | 12201 | polyimide with (phenol phenolic) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:42 |
| L10 | 38 | L9 and 14 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:42 |
| L11 . | 564847 | epox\$6 diepox\$6 polyepox\$6 glycidyl\$ diglycidyl\$ polyglycidyl\$ | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:42 |
| L12 | 37 | L9 and l4 and L11 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:43 |

| L13 | 130 | 14 and 11 I | US-PGPUB; | OR | ON | 2006/02/13 09:43 |
|-----|--------|--|--|-----|----|------------------|
| | | | USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | | | |
| L14 | 297027 | curative hardener (cross adj linker) crosslinker ((curing hardening (cross adj linking) crosslinking) adj2 (agent promoter)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:58 |
| L15 | 3017 | L9 and L11 and L14 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:58 |
| L16 | 595 | shiobara-toshio.in. shiobara-toshio-\$.in. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:58 |
| L17 | 46 | ichiroku-nobuhiro.in. ichiroku-nobuhiro-\$.in. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:58 |
| L18 | 58 | akiba-hideki.in, akiba-hideki-\$.in. | US-PGPUB; USPAT; USOCR; | OR | ON | 2006/02/13 09:58 |
| * | | | EPO; JPO; DERWENT ; IBM_TDB | | | |
| L19 | 67 | yoshino-masachika.in. yoshino-masachika-\$.in. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 09:58 |
| L20 | 685 | L16 L17 L18 L19 | US-PGPUB; USPAT; | OR. | ON | 2006/02/13 09:58 |
| | .0 | | USOCR; EPO; JPO; DERWENT .; IBM_TDB | | | |
| L22 | 24 | L15 and L20 and (bonding adhesive) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:07 |
| L23 | 1039 | polyimide with (phenol phenolic) with (bearing modified moiety radical) | US-PGPUB; USPAT; | OR | ON | 2006/02/13 11:25 |
| | | | USOCR; EPO; JPO; DERWENT ;IBM_TDB | | | |
| L24 | 383 | 111 and 123 and 114 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:08 |

| L25 | 33921 | polyimide same II I | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:09 |
|-----|--------|--|--|-----|----|------------------|
| L26 | 367 | 124 and 125 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:12 |
| L27 | 71929 | polyimide.ab. polyimide.ti. polyimide.clm. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:12 |
| L28 | 118 | 126 and 127 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:15 |
| L29 | 459340 | silicone polysiloxane polyorganosiloxane polydiorganosiloxane organopolysiloxane organosiloxane diorganopolysiloxane siloxane organosilicone | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:15 |
| L30 | 15492 | polyimide with 129 | US-PGPUB; | .OR | ОЙ | 2006/02/13 11:16 |
| | | | USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | | | |
| L31 | 13032 | polyimide with (phenol phenolic hydroxy hydroxyl) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:16 |
| L32 | 240 | polyimide with (phenol phenolic hydroxy hydroxyl) with (termin\$6) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT | OR | ON | 2006/02/13 11:17 |
| | | | ; IBM_TDB | | | |
| L33 | 297027 | 114 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:17 |
| L34 | 529 | polyimide and (129 dimethylpolysiloxane) and 114 and (polyimide same 111) and (polyimide same (adhesive bonding tape)) and 131 | US-PGPUB; | OR | ON | 2006/02/13 11:23 |
| | | 1117 and (polyntime same (autesive boilding tape)) and 151 | USPAT; USOCR; | | | |
| | n n | | EPO; JPO; DERWENT ; IBM_TDB | | | |
| L35 | 23 | polyimide and (129 dimethylpolysiloxane) and 114 and (polyimide same 111) and (polyimide same (adhesive bonding tape)) and 132 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:21 |

| L36 | 369 | polyimide and (129 dimethylpolysiloxane polydimethylsiloxane) and 114 and (polyimide with 111) and (polyimide with (adhesive bonding tape)) and 131 | US-PGPUB; USPAT; USOCR; | OR | ON | 2006/02/13 11:25 |
|-----|-------|--|---|----|----|------------------|
| | | | EPO; JPO; DERWENT ; IBM_TDB | | | |
| L37 | 1223 | polyimide with (phenol phenolic hydroxy hydroxyl) with (bearing modified moiety radical) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:25 |
| L38 | 70 | polyimide and (129 dimethylpolysiloxane polydimethylsiloxane) and 114 and (polyimide with 111) and (polyimide with (adhesive bonding tape)) and 137 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:58 |
| L39 | 8163 | (polyimide with 111).ab. (polyimide with 111).ti. (polyimide with 111).clm. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 12:00 |
| L40 | 499 | 139 and 114 and (129 dimethylpolysiloxane polydimethylsiloxane) and (adhesive bonding tape) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:35 |
| L41 | 12 | 132 and 140 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT | OR | ON | 2006/02/13 11:48 |
| L43 | 21624 | 525/474.ccls. 525/476.ccls. 525/523.ccls. 525/533.ccls. 525/928.ccls. 525/929.ccls. 428/413.ccls. 428/416.ccls. 428/416.ccls. 428/418.ccls. 428/446.ccls. 428/4473.5.ccls. | ; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:47 |
| L44 | 271 | 139 and 143 | US-PGPUB; | OR | ON | 2006/02/13 11:48 |
| | | | USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | | | |
| L45 | 22 | 139 and 143 and 137 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:48 |
| L46 | 39 | 137 and 140 | US-PGPUB; USPAT; USOCR; EPO; JPO; | OR | ON | 2006/02/13 11:48 |
| L47 | 52 | 145 146 | DERWENT;; IBM_TDB; US-PGPUB; USPAT; USOCR; | OR | ON | 2006/02/13 11:56 |
| | | | EPO; JPO; DERWENT ; IBM_TDB | | | |

| | | | non | 0.5 | - | 0006/00000 |
|-----|--------|---|--|-----|------|------------------|
| L48 | 163258 | silane organosilane alkoxysilane oxysilane | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:56 |
| L49 | 44 | polyimide and (129 dimethylpolysiloxane polydimethylsiloxane) and 114 and (polyimide with 111) and (polyimide with (adhesive bonding tape)) and 137 and 148 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:58 |
| L50 | 784 | 139 and 148 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:58 |
| L51 | 20896 | (polyimide with (adhesive bonding tape)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:58 |
| L52 | 188 | 150 and 151 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 11:58 |
| L54 | 89 | (polyimide with 111) ab. and (adhesive bonding tape) and 148 | US-PGPUB; USPAT; | OR | ON | 2006/02/13 12:01 |
| | | | USOCR; EPO; JPO; DERWENT ; IBM_TDB | | * | |
| L55 | 29 | (polyimide with 111).ab. and (adhesive bonding tape) and 148 and 114 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/13 12:08 |
| L56 | 6. | "5677393".pn. jp-09067558-\$.did. jp-03221756-\$.did. | US-PGPUB; | OR | ON | 2006/02/13 12:08 |
| | | | USPAT; USOCR; | 200 | | |
| | | | EPO; JPO; | | · '1 | |
| | | | DERWENT ; IBM_TDB | | | |
| S2 | 179814 | ероху | USPAT | OR | OFF | 2006/02/10 14:39 |
| S3 | 12200 | polyimide with (phenol phenolic) | US-PGPUB; USPAT; | OR | ON | 2006/02/13 09:40 |
| | | | USOCR; EPO; JPO; | | r | |
| | | | DERWENT | r | | |
| . | 564500 | | ; IBM_TDB | | | |
| S4 | 564730 | epox\$6 diepox\$6 polyepox\$6 glycidyl\$ diglycidyl\$ polyglycidyl\$ | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 14:45 |
| S5 | 296939 | curative hardener (cross adj linker) crosslinker ((curing hardening (cross adj linking) crosslinking) adj2 (agent promoter)) | US-PGPUB; USPAT; USOCR; | OR | ON | 2006/02/10 14:46 |
| | | | EPO; JPO; DERWENT ; IBM_TDB | | | |

| S6 | 3017 | S3 and S4 and S5 | US-PGPUB; | OR | ON | 2006/02/10 14:47 |
|-----|------|--|--|-----|-------------|------------------|
| 53 | 30.7 | | USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | | 0.11 | 2500021017.47 |
| S7 | 0 | S6 and wafter | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 14:47 |
| S8 | 295 | S6 and wafer | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 14:48 |
| S9 | 104 | S6 and (wafer same (bonding adhesive)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON . | 2006/02/10 14:57 |
| S10 | 1947 | polyimide same S4 same S5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 14:51 |
| S11 | . 52 | S9 and S10 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 14:51 |
| S12 | 927 | polyimide with (phenol phenolic) with (bearing modified) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM TDB | OR | ON | 2006/02/10 14:57 |
| S13 | 345 | S12 and S4 and S5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 14:57 |
| S14 | 28 | S13 and (wafer same (bonding adhesive)) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 15:01 |
| S15 | 128 | \$12.ab. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR. | ON | 2006/02/10 15:01 |
| S16 | 20 | S15 and S4 and S5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 15:09 |

| S17 | 2141 | S3.ab. | US-PGPUB; | OR | ON | 2006/02/10 15:09 |
|-------|------|--|--|-----|------|------------------|
| | | | USPAT; USOCR; EPO; JPO; DERWENT | | | |
| S18 | 126 | S17 and S4 and S5 | ; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; | OR | ON | 2006/02/10 15:09 |
| 3.0 | 126 | 017 104 105 | DERWENT ; IBM_TDB | on. | 0.1 | 2004/02/10 15 25 |
| S19 | 126 | S17 and S4 and S5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 15:27 |
| S20 | 595 | shiobara-toshio.in. shiobara-toshio-\$.in. | US-PGPUB; USPAT; | OR | ON | 2006/02/10 15:27 |
| | | | USOCR; EPO; JPO; DERWENT ; IBM_TDB | 8 | | |
| S21 | 46 | ichiroku-nobuhiro.in. ichiroku-nobuhiro-\$.in. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 15:28 |
| S22 | 58 | akiba-hideki.in. akiba-hideki-\$.in. | US-PGPUB; USPAT; | OR | ON | 2006/02/10 15:28 |
| | | | USOCR; EPO; JPO; DERWENT ; IBM_TDB | | | |
| S23 | 67 | yoshino-masachika.in. yoshino-masachika-\$.in. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 15:28 |
| S24 . | 7 | S20 and S21 and S22 and S23 | US-PGPUB; USPAT; | OR | ON | 2006/02/10 15:29 |
| | | | USOCR; EPO; JPO; DERWENT | | | |
| S25 | 685 | S20 S21 S22 S23 | ; IBM_TDB US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT | OR | ON | 2006/02/10 15:29 |
| S26 | 5 | S6 and S24 | ; IBM_TDB US-PGPUB; | OR | ON . | 2006/02/10 15:30 |
| | | | USPAT; USOCR; EPO; JPO; | | | |
| 00- | | | DERWENT ; IBM_TDB | | | e lanet Taret |
| S27 | 25 | S6 and S25 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB | OR | ON | 2006/02/10 15:49 |

| S28 | 4 | S6 and S25 and (bonding adhesive) and wafer | US-PGPUB; USPAT; USOCR; | OR | ON | 2006/02/13 09:58 | |
|-----|---|---|-------------------------------|----|----|------------------|--|
| | | | EPO; JPO; DERWENT | | | | |
| | | | ; IBM_TDB | | | | |